

## FEATURES

- Wide input voltage range: 3.15 V to 14 V**
- Wide output voltage range: 0.8 V to input voltage**
- Pin-to-pin compatible with LTC1772, LTC3801**
- Up to 94% efficiency**
- 0.8 V  $\pm$  1.25% reference accuracy over temperature**
- Internal soft start**
- 100% duty cycle for low dropout voltage**
- Current-mode operation for good line and load transient response**
- 7  $\mu$ A shutdown supply current**
- 235  $\mu$ A quiescent supply current**
- Short-circuit and overvoltage protection**
- Small 6-lead TSOT package**
- Supported by ADIsimPower™ design tool**

## APPLICATIONS

- Wireless devices**
- 1- to 3-cell Li-Ion battery-powered applications**
- Set-top boxes**
- Processor core power supplies**
- Hard disk drives**

## GENERAL DESCRIPTION

The ADP1864 is a compact, inexpensive, constant-frequency, current-mode, step-down dc-to-dc controller. The ADP1864 drives a P-channel MOSFET that regulates an output voltage as low as 0.8 V with  $\pm 1.25\%$  accuracy, for up to 5 A load currents, from input voltages as high as 14 V.

The ADP1864 provides system flexibility by allowing accurate setting of the current limit with an external resistor, and the output voltage is easily adjustable using two external resistors. The ADP1864 includes an internal soft start to allow quick power-up while preventing input inrush current. Additional safety features include short-circuit protection, output overvoltage protection, and input undervoltage protection. Current-mode control provides fast and stable load transient performance, while the 580 kHz operating frequency allows a small inductor to be used in the system. To further the life of a battery source, the controller turns on the external P-channel MOSFET 100% of the duty cycle during dropout.

The ADP1864 operates over the  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  temperature range and is available in a small, low profile, 6-lead TSOT package.

## TYPICAL APPLICATIONS DIAGRAM

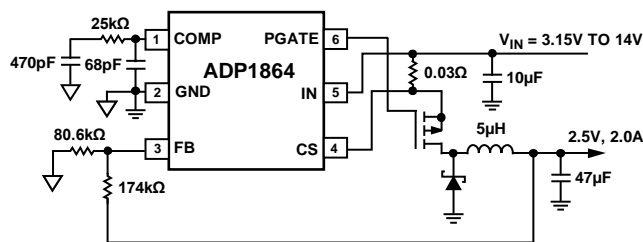


Figure 1.

## Rev. C

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## REVISION HISTORY

### 8/12—Rev. B to Rev. C

Change to Features Section .....	1
Added ADIsimPower Design Tool Section.....	10
Updated Outline Dimensions .....	14
Changes to Ordering Guide .....	14

### 4/08—Rev. A to Rev. B

Change General Description Section.....	1
Deleted Figure 2.....	1
Change to FB Regulation Voltage Parameter.....	3
Change to MOSFET Section .....	11
Changes to Ordering Guide .....	14

### 2/07—Rev 0. to Rev. A

Updated Format.....	Universal
Changes to Figure 1.....	1
Changes to General Description .....	2
Changes to Specifications .....	3
Change to Figure 13 .....	8
Replaced Layout Considerations Section .....	12
Replaced Example Applications Circuits Section .....	13

### 10/05—Revision 0: Initial Version

## SPECIFICATIONS

$V_{IN} = 5\text{ V}$ ,  $T_J = 25^\circ\text{C}$ , unless otherwise noted.

Table 1.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>POWER SUPPLY</b>						
Input Voltage	$V_{IN}$		3.15		14	V
Quiescent Current	$I_Q$	$V_{IN} = 3.15\text{ V to }14\text{ V}$ , PGATE = IN		235	360	$\mu\text{A}$
Shutdown Supply Current	$I_{SD}$	$V_{IN} = 3.15\text{ V to }14\text{ V}$ , COMP = GND		7	15	$\mu\text{A}$
Undervoltage Lockout Threshold	$V_{UVLO}$	$V_{IN}$ falling, $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	2.75	2.90	3.01	V
		$V_{IN}$ rising, $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	2.85	3.00	3.15	V
<b>ERROR AMPLIFIER</b>						
FB Input Current	$I_{FB}$	$V_{FB} = 0.8\text{ V}$ , $T_J = 25^\circ\text{C}$	-20	-2	+20	nA
		$V_{FB} = 0.8\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	-40	-2	+40	nA
Amplifier Transconductance		$V_{FB} = 0.8\text{ V}$ , $I_{COMP} = \pm 5\ \mu\text{A}$		0.24		mmho
COMP Startup Threshold		$V_{IN} = 3.15\text{ V to }14\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	0.55	0.67	0.80	V
COMP Shutdown Threshold		$V_{IN} = 3.15\text{ V to }14\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	0.15	0.3	0.55	V
COMP Start-Up Current Source		COMP = GND	0.25	0.6	0.95	$\mu\text{A}$
FB Regulation Voltage		$V_{IN} = 3.15\text{ V to }14\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	0.790	0.8	0.810	V
Overvoltage Protection Threshold	$V_{OVP}$	Measured at FB, $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	0.87	0.885	0.9	V
Overvoltage Protection Hysteresis				50		mV
<b>CURRENT SENSE</b>						
Peak Current Sense Voltage		$T_J = -40^\circ\text{C to }+125^\circ\text{C}$	90	125		mV
		$V_{IN} = 3.15\text{ V to }14\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	70	125		mV
Current Sense Gain		$V_{CS}$ to $V_{COMP}$		12		V/V
<b>OUTPUT REGULATION</b>						
Line Regulation <sup>1</sup>		$V_{IN} = 3.15\text{ V to }14\text{ V}$ , $V_{FB}/V_{IN}$		0.12		mV/V
Load Regulation <sup>2</sup>		$V_{FB}/V_{COMP}$		-2		mV/V
<b>OSCILLATOR</b>						
Oscillator Frequency		$V_{FB} = 0.8\text{ V}$ , $T_J = -40^\circ\text{C to }+125^\circ\text{C}$	500	580	650	kHz
		$V_{FB} = 0\text{ V}$		190		kHz
FB Frequency Foldback Threshold				0.35		V
<b>GATE DRIVE</b>						
Gate Rise Time		$C_{GATE} = 3\text{ nF}$		50		ns
Gate Fall Time		$C_{GATE} = 3\text{ nF}$		40		ns
Minimum On Time		PGATE minimum low duration		190		ns
SOFT START POWER-ON TIME				1.1		ms

<sup>1</sup> Line regulation is measured using the application circuit in Figure 1. Line regulation is specified as the change in the FB voltage resulting from a 1 V change in the IN voltage.

<sup>2</sup> Load regulation is measured using the application circuit in Figure 1. Load regulation is specified as the change in the FB voltage resulting from a 1 V change in the COMP voltage. The COMP voltage range is typically 0.9 V to 2.3 V for the minimum to maximum load current condition.

## ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
IN to GND	-0.3 V to +16 V
CS, PGATE to GND	-0.3 V to ( $V_{IN} + 0.3$ V)
FB, COMP to GND	-0.3 V to +6 V
$\theta_{JA}$ 2-Layer (SEMI Standard Board)	315°C/W
$\theta_{JA}$ 4-Layer (JEDEC Standard Board)	186°C/W
Operating Junction Temperature Range	-40°C to +125°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature	
Rework Temperature (J-STD-020B)	260°C
Peak Reflow Temperature, (20 sec to 40 sec, J-STD-020B)	260°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

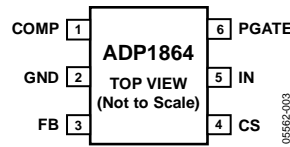


Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	COMP	Regulator Compensation Node. COMP is the output of the internal transconductance error amplifier. Connect a series RC from COMP to GND to compensate for the control loop. Add an extra high frequency capacitor between COMP and GND to further reduce switching jitter. The value of this is typically one-tenth of the main compensation capacitor. Pulling the COMP pin below 0.3 V disables the ADP1864 and turns off the external PFET.
2	GND	Analog Ground. Directly connect the compensation and feedback networks to GND, preferably with a small analog GND plane. Connect GND to the power ground (PGND) plane with a narrow track at a single point close to the GND pin. See the Layout Considerations section for more information.
3	FB	Feedback Input. Connect a resistive voltage divider from the output voltage to FB to set the output voltage. The regulation feedback voltage is 0.8 V. Place the feedback resistors as close as possible to the FB pin.
4	CS	Current Sense Input. CS is the negative input of the current sense amplifier. It provides the current feedback signal used to terminate the PWM on time. Place a current sense resistor between IN and CS to set the current limit. The current limit threshold is typically 125 mV.
5	IN	Power Input. IN is the power supply to the ADP1864 and the positive input of the current sense amplifier. Connect IN to the positive side of the input voltage source. Bypass IN to PGND with a 10 $\mu$ F or larger capacitor as close as possible to the ADP1864. For additional high frequency noise reduction, add a 0.1 $\mu$ F capacitor to PGND at the IN pin.
6	PGATE	Gate Drive Output. PGATE drives the gate of the external P-channel MOSFET. Connect PGATE to the gate of the external MOSFET.

TYPICAL PERFORMANCE CHARACTERISTICS

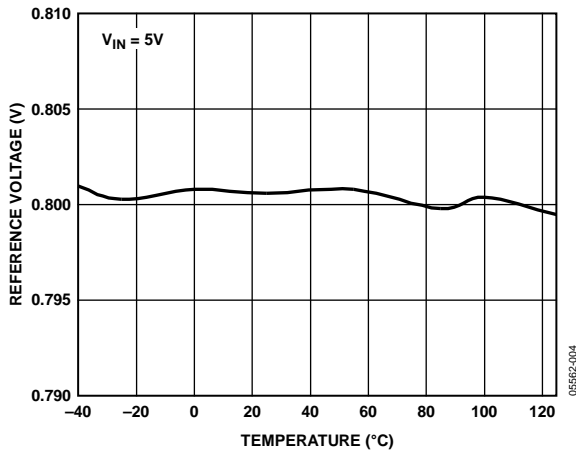


Figure 3. Reference Voltage vs. Temperature

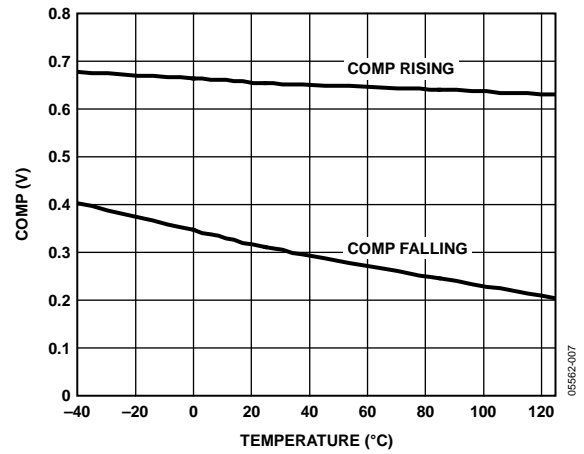


Figure 6. COMP Shutdown Threshold vs. Temperature

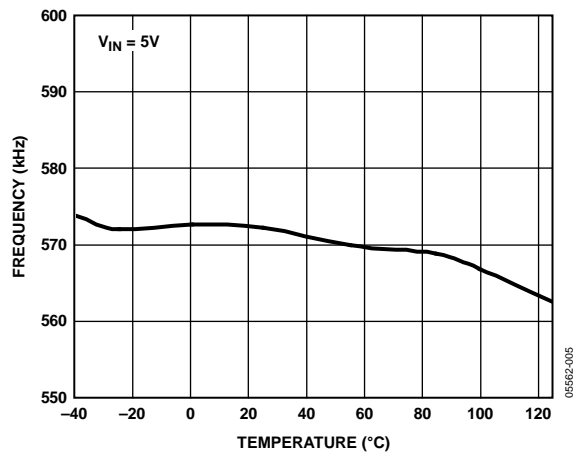


Figure 4. Normalized Oscillator Frequency vs. Temperature

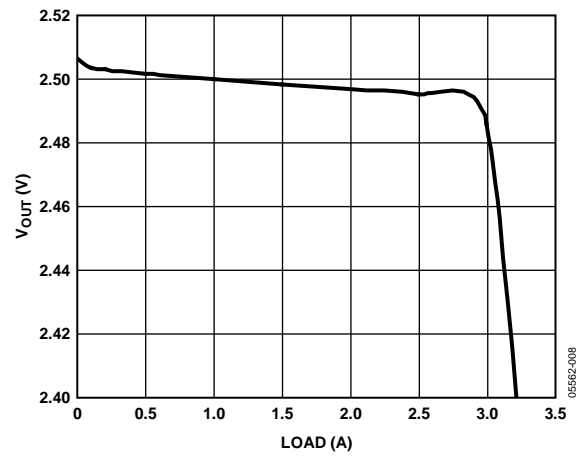


Figure 7. Typical Load Regulation ( $V_{IN} = 5V$ ; See Figure 1)

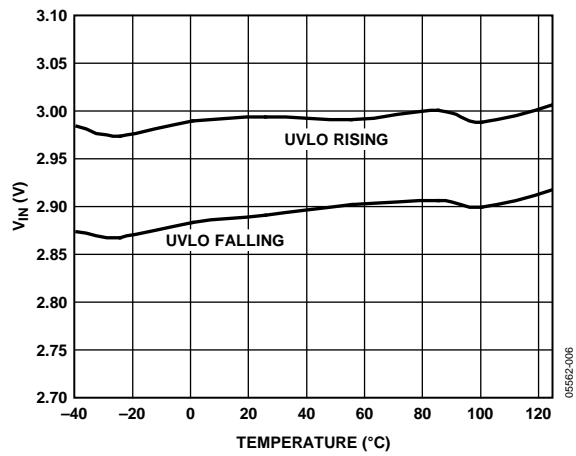


Figure 5. UVLO Voltage vs. Temperature ( $V_{IN}$  Rising and  $V_{IN}$  Falling)

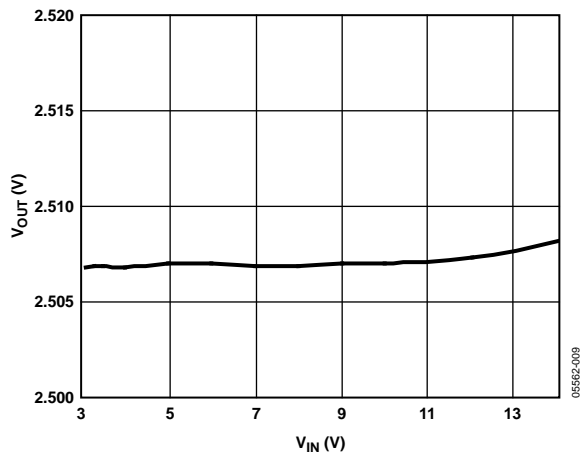


Figure 8. Typical Line Regulation vs. Input Voltage (See Figure 19)

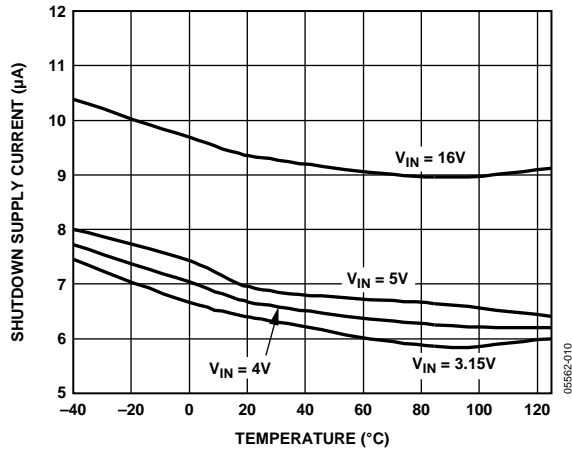


Figure 9. Shutdown Supply Current vs. Temperature

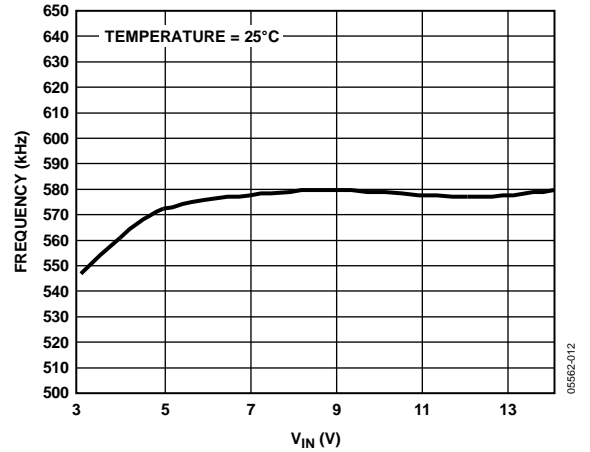


Figure 11. Oscillator Frequency vs. Input Voltage

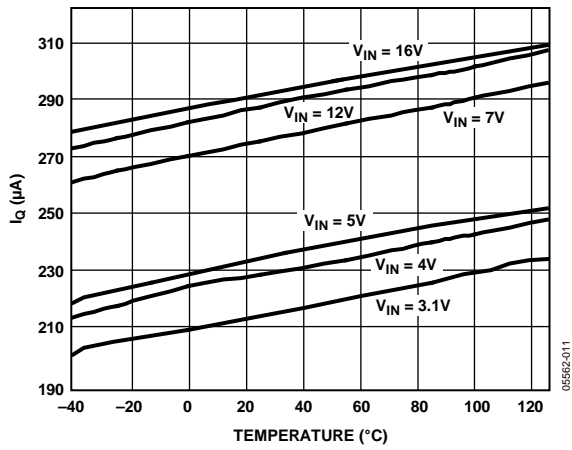


Figure 10. Quiescent Current vs. Temperature

## THEORY OF OPERATION

The ADP1864 is a constant frequency (580 kHz), current-mode buck controller. PGATE drives the gate of the external P-channel FET. The duty cycle of the external FET dictates the output voltage and the current supplied to the load.

The peak inductor current is measured across the external sense resistor, while the system output voltage is fed back through an external resistor divider to the FB pin.

At the start of every oscillator cycle, PGATE turns on the external FET, causing the inductor current, and therefore the current sense amplifier voltage, to increase. The inductor current increases until the current amplifier voltage equals the voltage at the COMP pin. This resets the internal flip-flop, causing PGATE to go high and turning off the external FET. The inductor current decreases until the beginning of the next oscillator period.

The voltage at the COMP node is the output of the internal error amplifier. The negative input of the error amplifier is the output voltage scaled by an external resistive divider, and the

positive input to the error amplifier is driven by a 0.8 V band gap reference. An increase in the load current causes a small drop in the feedback voltage, in turn causing an increase in the COMP voltage and, therefore, the duty cycle. The resulting increase in the on time of the FET provides the additional current required by the load.

## LOOP STARTUP

Pulling the COMP pin to GND disables the ADP1864. When the COMP pin is released from GND, an internal 0.6  $\mu\text{A}$  current source charges the external compensation capacitor on the COMP node. Once the COMP voltage has charged to 0.67 V, the internal control blocks are enabled and COMP is pulled up to its minimum normal operating voltage (0.9 V). As the voltage at COMP continues to increase, the on time of the external FET increases to supply the required inductor current. The loop stabilizes completely once the COMP voltage is sufficiently high to support the load current. The regulation voltage at FB is 0.8 V.

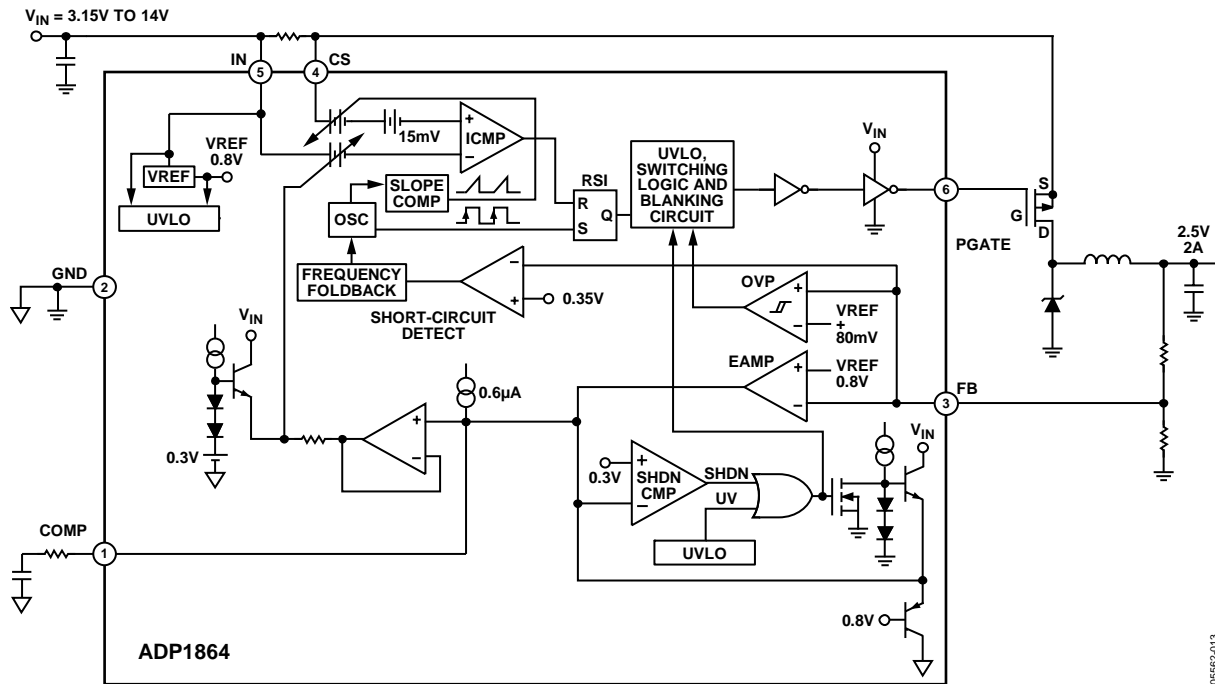


Figure 12. Functional Block Diagram

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**SHORT-CIRCUIT PROTECTION**

If there is a short across the output load, the voltage at the feedback pin (FB) drops rapidly. When the FB voltage drops below 0.35 V, the ADP1864 reduces the oscillator frequency to 190 kHz. The increase in the oscillator period allows the inductor additional time to discharge, preventing the output current from running away. Once the output short is removed and the feedback voltage increases above the 0.35 V threshold, the oscillator frequency returns to 580 kHz.

**UNDERVOLTAGE LOCKOUT (UVLO)**

To prevent erratic operation when the input voltage drops below the minimum acceptable voltage, the ADP1864 has an undervoltage lockout (UVLO) feature. If the input voltage drops below 2.90 V, PGATE is pulled high and the ADP1864 continues to draw its typical quiescent current. Current consumption continues to drop toward the shutdown current as input voltage is reduced. The ADP1864 is re-enabled and begins switching once the IN voltage is increased above the UVLO rising threshold (3.0 V).

**OVERVOLTAGE LOCKOUT PROTECTION (OVP)**

The ADP1864 provides an overvoltage protection feature to protect the system against output short circuits to a higher voltage supply. If the feedback voltage increases to 0.885 V, PGATE is held high, turning the external FET off. The FET continues to be held high until the voltage at FB decreases to 0.84 V, at which time the ADP1864 resumes normal operation.

**SOFT START**

The ADP1864 includes a soft start feature that limits the rate of increase in the inductor current once the part is enabled. Soft start is activated when the input voltage is increased above the UVLO threshold or COMP is released from GND. Soft start limits the inrush current at the input and limits the output voltage overshoot. The soft start control slope is set internally.

## APPLICATIONS INFORMATION

### ADIsimPower DESIGN TOOL

The ADP1864 is supported by [ADIsimPower](#) design tool set. [ADIsimPower](#) is a collection of tools that produce complete power designs optimized for a specific design goal. The tools enable the user to generate a full schematic, bill of materials, and calculate performance in minutes. [ADIsimPower](#) can optimize designs for cost, area, efficiency, and parts count while taking into consideration the operating conditions and limitations of the IC and all real external components. For more information about [ADIsimPower](#) design tools, refer to [www.analog.com/ADIsimPower](http://www.analog.com/ADIsimPower). The tool set is available from this website, and users can also request an unpopulated board through the tool.

### DUTY CYCLE

To determine the worst-case inductor ripple current, output voltage ripple, and slope compensation factor, establish the system maximum and minimum duty cycle. The duty cycle is calculated by the equation

$$\text{Duty Cycle (DC)} = \frac{V_{OUT} + V_D}{V_{IN} + V_D} \quad (1)$$

where  $V_D$  is the diode forward drop.

A typical Schottky diode has a forward voltage drop of 0.5 V.

### RIPPLE CURRENT

Choose the peak-to-peak inductor ripple current between 20% and 40% of the maximum load current at the system's highest input voltage. A good starting point for a design is to pick the peak-to-peak ripple current at 30% of the load current.

$$\Delta I_{(PEAK)} = 0.3 \times I_{LOAD(MAX)} \quad (2)$$

### SENSE RESISTOR

Choose the sense resistor value to provide the desired current limit. The internal current comparator measures the peak current (sum of load current and positive inductor ripple current) and compares it against the current limit threshold. The current sense resistor value is calculated by the equation

$$R_{SENSE(MIN)} = \frac{PCSV}{I_{LOAD(MAX)} + \frac{\Delta I_{(PEAK)}}{2}} \quad (3)$$

where  $PCSV$  is the peak current sense voltage, typically 0.125 V.

To ensure the design provides the required output load current over all system conditions, consider the variation in  $PCSV$  over temperature (see the Specifications section) as well as increases in ripple current due to inductor tolerance.

If the system is being operated with >40% duty cycle, incorporate the slope compensation factor into the calculation.

$$R_{SENSE(MIN)} = \frac{SF \times PCSV}{I_{LOAD(MAX)} + \frac{\Delta I_{(PEAK)}}{2}} \quad (4)$$

where  $SF$  is the slope factor correction ratio, taken from Figure 13, at the system maximum duty cycle (minimum input voltage).

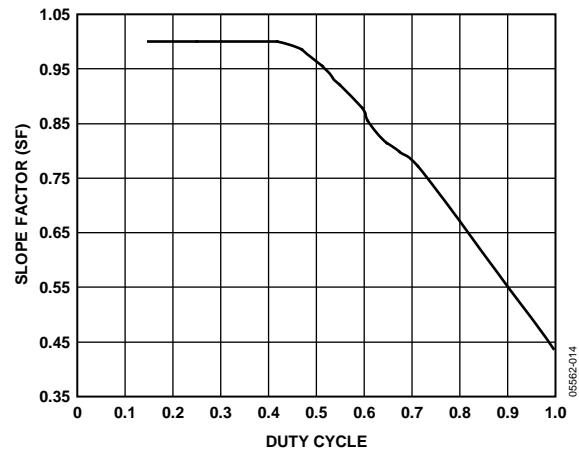


Figure 13. Slope Factor (SF) vs. Duty Cycle

### INDUCTOR VALUE

The inductor value choice is important because it dictates the inductor ripple and, therefore, the voltage ripple at the output. When operating the part at >40% duty cycle, keep the inductor value low enough for the slope compensation to remain effective.

The inductor ripple current is inversely related to the inductor value.

$$\Delta I_{(PEAK)} = \frac{(V_{IN} - V_{OUT})}{L \times f} \times \left( \frac{V_{OUT} + V_D}{V_{IN} + V_D} \right) \quad (5)$$

where  $f$  is the oscillator frequency.

Smaller inductor values are usually less expensive, but increase the ripple current and the output voltage ripple. Too large an inductor value results in added expenses and can impede effective load transient responses at >40% duty cycle because it reduces the effect of slope compensation.

Start with the highest input voltage, and assuming the ripple current is 30% of the maximum load current,

$$L = \frac{(V_{IN} - V_{OUT})}{0.3 \times I_{LOAD(MAX)} \times f} \times \left( \frac{V_{OUT} + V_D}{V_{IN} + V_D} \right) \quad (6)$$

From this starting point, modify the inductance to obtain the right balance of size, cost, and output voltage ripple, while maintaining the inductor ripple current between 20% and 40% of the maximum load current.

## MOSFET

Choose the external P-channel MOSFET based on the following: threshold voltage ( $V_T$ ), maximum voltage and current ratings,  $R_{DS(ON)}$ , and gate charge.

The minimum operating voltage of the ADP1864 is 3.15 V. Choose a MOSFET with a  $V_T$  that is at least 1 V lower than the minimum input supply voltage used in the application.

Ensure that the maximum ratings for MOSFET  $V_{SG}$  and  $V_{SD}$  are a few volts greater than the maximum input voltage used with the ADP1864.

Estimate the rms current in the MOSFET under continuous conduction mode by

$$I_{FET(rms)} = \sqrt{\frac{V_{OUT} + V_D}{V_{IN} + V_D}} \times I_{LOAD} \quad (7)$$

Derate the MOSFET current by at least 20% to account for inductor ripple and changes in the diode voltage.

The MOSFET power dissipation is the sum of the conducted and switching losses:

$$PD_{FET(COND)} = (I_{FET(rms)})^2 \times (1 + T) \times R_{DS(ON)} \quad (8)$$

where  $T = 0.005/^\circ\text{C} \times T_{J(FET)} - 25^\circ\text{C}$ .

Ensure the maximum power dissipation calculated is significantly less than the maximum rating of the MOSFET.

## DIODE

The diode carries the inductor current during the off time of the external FET. The average current of the diode is, therefore, dependent on the duty cycle of the controller as well as the output load current.

$$I_{DIODE(AV)} = \left(1 - \frac{V_{OUT} + V_D}{V_{IN} + V_D}\right) \times I_{LOAD} \quad (9)$$

where  $V_D$  is the diode forward drop.

A typical Schottky diode has a forward drop voltage of 0.5 V.

A Schottky diode is recommended for best efficiency because it has a low forward drop and faster switching speed than junction diodes. If a junction diode is used it must be an ultrafast recovery diode. The low forward drop reduces power losses during the FET off time, and fast switching speed reduces the switching losses during PFET transitions.

## INPUT CAPACITOR

The input capacitor provides a low impedance path for the pulsed current drawn by the external P-channel FET. Choose an input capacitor whose impedance at the switching frequency is lower than the impedance of the voltage source ( $V_{IN}$ ). The preferred input capacitor is a 10  $\mu\text{F}$  ceramic capacitor due to its low ESR and low impedance.

For all types of capacitors, make sure the ripple current rating of the capacitor is greater than half of the maximum output load current.

Where space is limited, multiple capacitors can be placed in parallel to meet the rms current requirement. Place the input capacitor as close as possible to the IN pin of the ADP1864.

## OUTPUT CAPACITOR

The ESR and capacitance value of the output capacitor determine the amount of output voltage ripple.

$$\Delta V \cong \Delta I \times \left( \frac{1}{8 \times f \times C_{OUT}} + ESR_{C_{OUT}} \right) \quad (10)$$

where  $f$  is the oscillator frequency (typically 580 kHz).

Because the output capacitance is typically  $>40 \mu\text{F}$ , the ESR dominates the voltage ripple. Ensure the output capacitor ripple rating is greater than the maximum inductor ripple.

$$I_{rms} \cong \frac{1}{2 \times \sqrt{3}} \times \left( \frac{(V_{OUT} + V_D) \times (V_{IN} - V_{OUT})}{L \times f \times V_{IN}} \right) \quad (11)$$

POSCAP™ capacitors from Sanyo offer a good size, ESR, ripple, and current capability trade-off.

## FEEDBACK RESISTORS

The feedback resistors ratio sets the output voltage of the system.

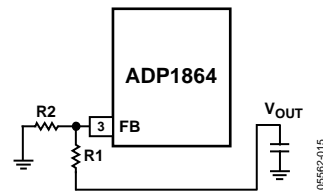


Figure 14. Two Feedback Resistors Used to Set Output Voltage

$$0.8 \text{ V} = V_{OUT} \times \frac{R2}{R1 + R2} \quad (12)$$

$$R1 = R2 \times \frac{(V_{OUT} - 0.8)}{0.8} \quad (13)$$

Choose 80.6 k $\Omega$  for R2. Using higher values for R2 results in reduced output voltage accuracy, and lower values cause an increased voltage divider current, thus increasing quiescent current consumption.

## LAYOUT CONSIDERATIONS

Layout is important with all switching regulators, but is particularly important for high switching frequencies. Ensure all high current paths are as wide as possible to minimize track inductance, which causes spiking and electromagnetic interference (EMI). These paths are shown in bold in Figure 15. Place the current sense resistor and the input capacitor(s) as close to the IN pin as possible.

Keep the PGND connections for the diode, input capacitor(s), and output capacitor(s) as close together as possible on a wide PGND plane. Connect the PGND and GND planes at a single point with a narrow trace close to the ADP1864 GND connection.

Ensure the feedback resistors are placed as close as possible to the FB pin to prevent stray pickup. To prevent extra noise pickup on the FB line, do not allow the feedback trace from the output voltage to FB to pass right beside the drain of the external PFET. Add an extra copper plane at the connection of the FET drain and the cathode of the diode to help dissipate the heat generated by losses in those components.

All analog components are grouped together on the left side of the evaluation board (left side of the ADP1864 DUT, see Figure 16), including compensation and FB components. All power components are located on the right side of the board (MOSFET, inductor, input bypass capacitors, output capacitors, and power diode).

All noisy nodes (P-channel drain, power diode cathode, and inductor terminal) are located along the bottom portion of the evaluation board on the top layer (see Figure 16). A substantial amount of copper has been allocated for this area with ample track spacing to minimize coupling (crosstalk) effects during switching.

The FB tap is isolated and runs from the  $R_{TOP}$ , along the upper right portion of the board on the bottom layer (see Figure 17) to minimize EMI pickups emitted from the power components along the bottom portion of the evaluation board's top layer (see Figure 16). Sufficient track spacing is placed from the main power ground plane located near the center of the board to effectively decouple this track.

There are two ground planes on the top layer: the analog ground plane is on the left and the power ground plane on the right. An analog ground pickup point projects down to the bottom layer and through a single narrow and isolated track (see Figure 17).

The P-channel gate should have an isolated trace (bottom layer) tying back to Pin 6 of the DUT by via connections.

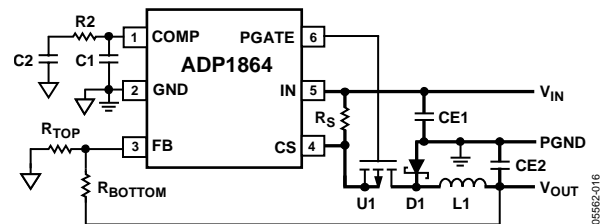


Figure 15. Application Circuit Showing High Current Paths (in Bold)

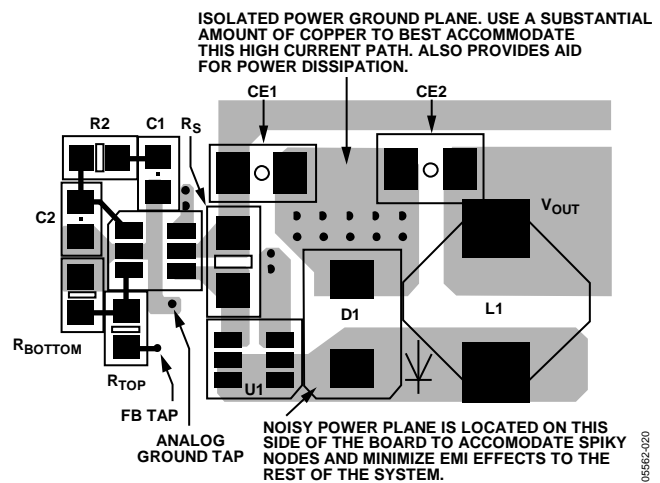
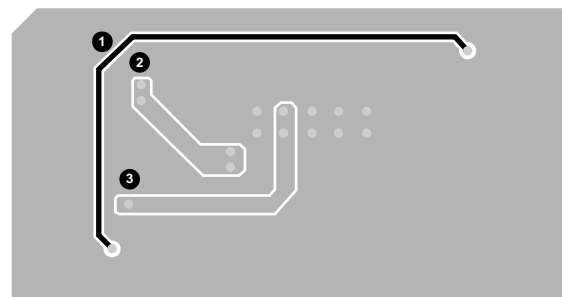


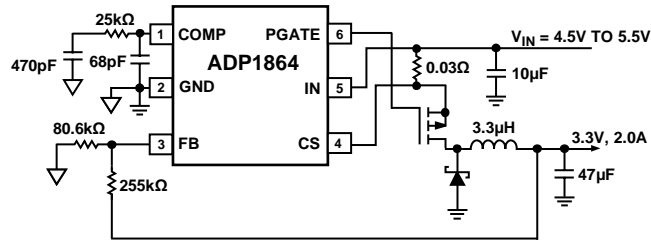
Figure 16. Top Layer of an Example Layout for an ADP1864 Application



1 FB TAP FROM OUTPUT TO  $R_{TOP}$ . TRACE SHOULD BE AWAY FROM POWER COMPONENTS TO MINIMIZE EMI PICKUP.  
2 ISOLATED TRACE FOR GATE CONNECTION OF THE PFET. ROUTING OF THIS CONNECTION AWAY FROM THE CATHODE OF D1 AND DRAIN OF PFET IS TO ENSURE THAT NOISE DOES NOT COUPLE INTO THIS TRACK.  
3 ISOLATED TRACK FOR CONNECTING AGND TO PGND. THIS HELPS MINIMIZE STRAY PARASITIC EFFECTS TOWARDS THE ANALOG COMPONENTS (FB AND COMPENSATION COMPONENTS).

Figure 17. Bottom Layer of an Example Layout of an ADP1864 Application

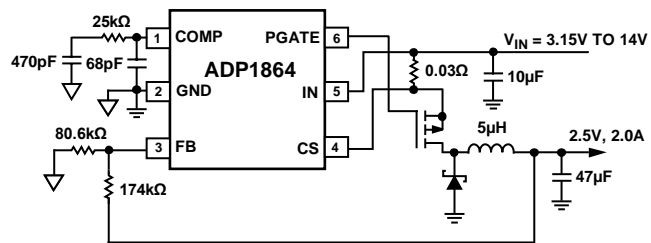
### EXAMPLE APPLICATIONS CIRCUITS



RSENSE LRC-LR1206-01-R030-F  
 MOSFET FAIRCHILD SEMI FDC638P  
 INDUCTOR TOKO FDV0630-3R3M  
 DIODE SYNSEMI SK22  
 CIN LMK325BJ106KN  
 COUT SANYO POSCAP 6TPB47M

05562-018

Figure 18. Application Circuit for  $V_{OUT} = 3.3\text{ V}$ , 2 A Load

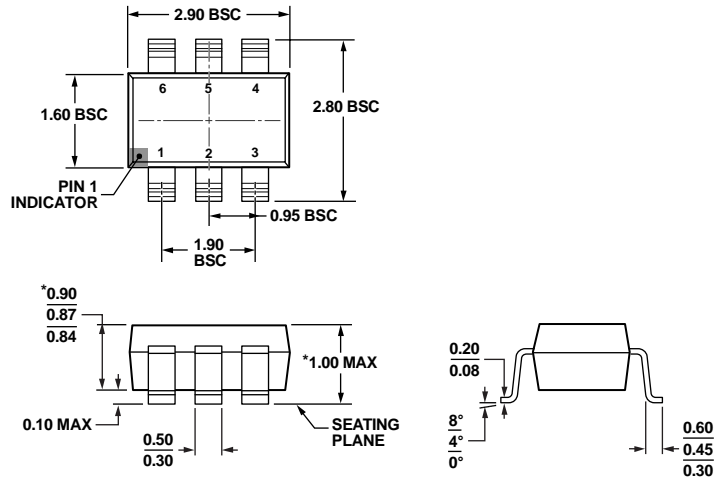


RSENSE LRC-LR1206-01-R030-F  
 MOSFET FAIRCHILD SEMI FDC658P  
 INDUCTOR SUMIDA CDRH6D38-5R0  
 DIODE VISHAY SSB43L  
 CIN LMK325BJ106KN  
 COUT SANYO POSCAP 6TPB47M

05562-019

Figure 19. Application Circuit for  $V_{OUT} = 2.5\text{ V}$ , 2 A Load

OUTLINE DIMENSIONS



\*COMPLIANT TO JEDEC STANDARDS MO-193-AA WITH THE EXCEPTION OF PACKAGE HEIGHT AND THICKNESS.

Figure 20. 6-Lead Thin Small Outline Transistor Package [TSOT] (UJ-6)

Dimensions shown in millimeters

102808-A

ORDERING GUIDE

Model <sup>1,2</sup>	Temperature Range	Package Description	Package Option	Branding
ADP1864AUJZ-R7	-40°C to +125°C	6-Lead Thin Small Outline Transistor Package [TSOT]	UJ-6	P0N
ADP1864-EVAL		Evaluation Board		
ADP1864-EVALZ		Evaluation Board		

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> V<sub>OUT</sub> = 2.5 V (variable), I<sub>LOAD</sub> = 0 A to 3 A, V<sub>IN</sub> = 3.15 V to 14 V.

**NOTES**

**NOTES**



Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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